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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	18144
Number of Logic Elements/Cells	-
Total RAM Bits	165888
Number of I/O	317
Number of Gates	1000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-55°C ~ 125°C (TA)
Package / Case	484-BGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ax1000-fgg484m

The maximum power dissipation allowed for Military temperature and Mil-Std 883B devices is specified as a function of θ_{jc} .

Table 2-6 • Package Thermal Characteristics

Package Type	Pin Count	θ_{jc}	θ_{ja} Still Air	θ_{ja} 1.0m/s	θ_{ja} 2.5m/s	Units
Chip Scale Package (CSP)	180	N/A	57.8	51.0	50	°C/W
Plastic Quad Flat Pack (PQFP)	208	8.0	26	23.5	20.9	°C/W
Plastic Ball Grid Array (PBGA)	729	2.2	13.7	10.6	9.6	°C/W
Fine Pitch Ball Grid Array (FBGA)	256	3.0	26.6	22.8	21.5	°C/W
Fine Pitch Ball Grid Array (FBGA)	324	3.0	25.8	22.1	20.9	°C/W
Fine Pitch Ball Grid Array (FBGA)	484	3.2	20.5	17.0	15.9	°C/W
Fine Pitch Ball Grid Array (FBGA)	676	3.2	16.4	13.0	12.0	°C/W
Fine Pitch Ball Grid Array (FBGA)	896	2.4	13.6	10.4	9.4	°C/W
Fine Pitch Ball Grid Array (FBGA)	1152	1.8	12.0	8.9	7.9	°C/W
Ceramic Quad Flat Pack (CQFP) ¹	208	2.0	22	19.8	18.0	°C/W
Ceramic Quad Flat Pack (CQFP) ¹	352	2.0	17.9	16.1	14.7	°C/W
Ceramic Column Grid Array (CCGA) ²	624	6.5	8.9	8.5	8	°C/W

Notes:

- θ_{jc} for the 208-pin and 352-pin CQFP refers to the thermal resistance between the junction and the bottom of the package.
- θ_{jc} for the 624-pin CCGA refers to the thermal resistance between the junction and the top surface of the package. Thermal resistance from junction to board (θ_{jb}) for CCGA 624 package is 3.4°C/W.

Timing Characteristics

Axcelerator devices are manufactured in a CMOS process, therefore, device performance varies according to temperature, voltage, and process variations. Minimum timing parameters reflect maximum operating voltage, minimum operating temperature, and best-case processing. Maximum timing parameters reflect minimum operating voltage, maximum operating temperature, and worst-case processing. The derating factors shown in Table 2-7 should be applied to all timing data contained within this datasheet.

Table 2-7 • Temperature and Voltage Timing Derating Factors
(Normalized to Worst-Case Commercial, $T_J = 70^\circ\text{C}$, $V_{CCA} = 1.425\text{V}$)

VCCA	Junction Temperature						
	-55°C	-40°C	0°C	25°C	70°C	85°C	125°C
1.4 V	0.83	0.86	0.91	0.96	1.02	1.05	1.15
1.425 V	0.82	0.84	0.90	0.94	1.00	1.04	1.13
1.5 V	0.78	0.80	0.85	0.89	0.95	0.98	1.07
1.575 V	0.74	0.76	0.81	0.85	0.90	0.94	1.02
1.6 V	0.73	0.75	0.80	0.84	0.89	0.92	1.01

Notes:

- The user can set the junction temperature in Designer software to be any integer value in the range of -55°C to 175°C.
- The user can set the core voltage in Designer software to be any value between 1.4V and 1.6V.

All timing numbers listed in this datasheet represent sample timing characteristics of Axcelerator devices. Actual timing delay values are design-specific and can be derived from the Timer tool in Microsemi's Designer software after place-and-route.

Table 2-8 • I/O Standards Supported by the Axcelerator Family

I/O Standard	Input/Output Supply Voltage (VCCI)	Input Reference Voltage (VREF)	Board Termination Voltage (VTT)
LVTTL	3.3	N/A	N/A
LVC MOS 2.5 V	2.5	N/A	N/A
LVC MOS 1.8 V	1.8	N/A	N/A
LVC MOS 1.5 V (JDEC8-11)	1.5	N/A	N/A
3.3V PCI/PCI-X	3.3	N/A	N/A
GTL+ 3.3 V	3.3	1.0	1.2
GTL+ 2.5 V*	2.5	1.0	1.2
HSTL Class 1	1.5	0.75	0.75
SSTL3 Class 1 and II	3.3	1.5	1.5
SSTL2 Class1 and II	2.5	1.25	1.25
LVDS	2.5	N/A	N/A
LVPECL	3.3	N/A	N/A

Note: *2.5 V GTL+ is not supported across the full military temperature range.

Table 2-9 • Supply Voltages

VCCA	VCCI	Input Tolerance	Output Drive Level
1.5 V	1.5 V	3.3 V	1.5 V
1.5 V	1.8 V	3.3 V	1.8 V
1.5 V	2.5 V	3.3 V	2.5 V
1.5 V	3.3 V	3.3 V	3.3 V

Table 2-10 • I/O Features Comparison

I/O Assignment	Clamp Diode	Hot Insertion	5 V Tolerance	Input Buffer	Output Buffer
LVTTL	No	Yes	Yes ¹	Enabled/Disabled	
3.3 V PCI, 3.3 V PCI-X	Yes	No	Yes ^{1, 2}	Enabled/Disabled	
LVC MOS 2.5 V	No	Yes	No	Enabled/Disabled	
LVC MOS 1.8 V	No	Yes	No	Enabled/Disabled	
LVC MOS 1.5 V (JESD8-11)	No	Yes	No	Enabled/Disabled	
Voltage-Referenced Input Buffer	No	Yes	No	Enabled/Disabled	
Differential, LVDS/LVPECL, Input	No	Yes	No	Enabled	Disabled ³
Differential, LVDS/LVPECL, Output	No	Yes	No	Disabled	Enabled ⁴

Notes:

1. Can be implemented with an IDT bus switch.
2. Can be implemented with an external resistor.
3. The OE input of the output buffer must be deasserted permanently (handled by software).
4. The OE input of the output buffer must be asserted permanently (handled by software).

5 V Tolerance

There are two schemes to achieve 5 V tolerance:

1. 3.3 V PCI and 3.3 V PCI-X are the only I/O standards that directly allow 5 V tolerance. To implement this, an internal clamp diode between the input pad and the VCCI pad is enabled so that the voltage at the input pin is clamped, as shown in EQ 3:

$$V_{\text{input}} = V_{\text{CCI}} + V_{\text{diode}} = 3.3 \text{ V} + 0.7 \text{ V} = 4.0 \text{ V}$$

EQ 3

The internal VCCI clamp diode is only enabled while the device is powered on, so the voltage at the input will not be clamped if the VCCI or VCCA are powered off. An external series resistor (~100 Ω) is required between the input pin and the 5 V signal source to limit the current to less than 20 mA (Figure 2-3). The 100 Ω resistor was chosen to meet the input Tr/Tf requirement (Table 2-19 on page 2-21). The GND clamp diode is available for all I/O standards and always enabled.

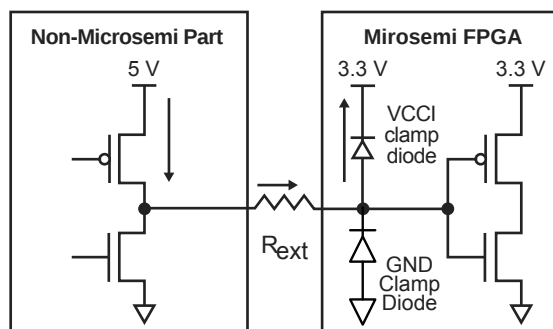


Figure 2-3 • Use of an External Resistor for 5 V Tolerance

2. 5 V tolerance can also be achieved with 3.3 V I/O standards (3.3 V PCI, 3.3 V PCI-X, and LVTTTL) using a bus-switch product (e.g. IDTQS32X2384). This will convert the 5 V signal to a 3.3 V signal with minimum delay (Figure 2-4).

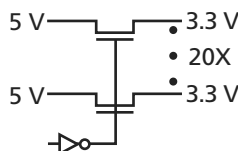


Figure 2-4 • Bus Switch IDTQS32X2384

Simultaneous Switching Outputs (SSO)

When multiple output drivers switch simultaneously, they induce a voltage drop in the chip/package power distribution. This simultaneous switching momentarily raises the ground voltage within the device relative to the system ground. This apparent shift in the ground potential to a non-zero value is known as simultaneous switching noise (SSN) or more commonly, ground bounce.

SSN becomes more of an issue in high pin count packages and when using high performance devices such as the Axcelerator family. Based upon testing, Microsemi recommends that users not exceed eight simultaneous switching outputs (SSO) per each VCCI/GND pair. To ease this potential burden on designers, Microsemi has designed all of the Axcelerator BGAs³ to not exceed this limit with the exception of the CS180, which has an I/O to VCCI/GND pair ratio of nine to one.

Please refer to the *Simultaneous Switching Noise and Signal Integrity* application note for more information.

3. The user should note that in Bank 8 of both AX1000-FG484 and AX500-FG484, there are local violations of this 8:1 ratio.

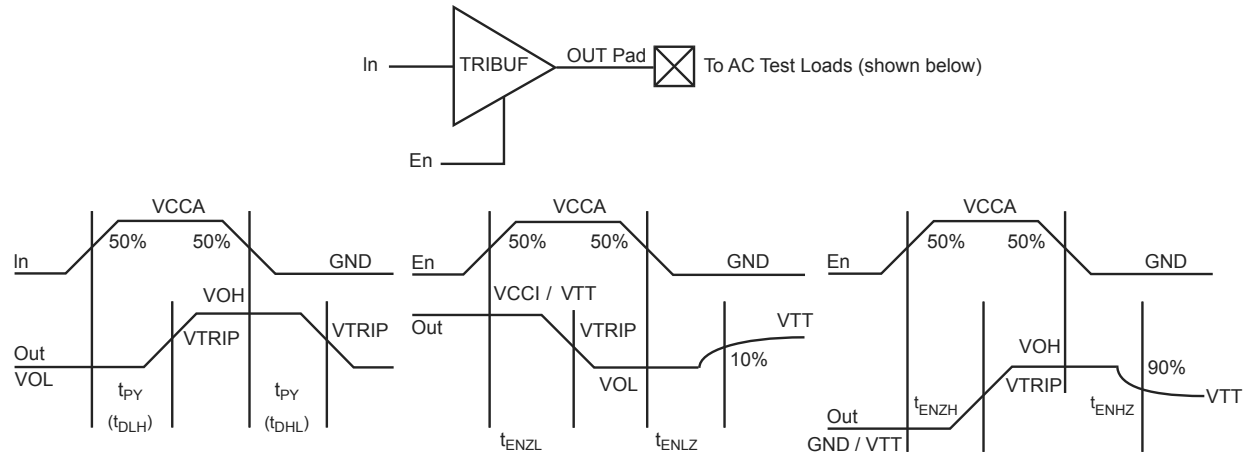


Figure 2-10 • Output Buffer Delays

Timing Characteristics

Table 2-22 • 3.3 V LVTTL I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_j = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
LVTTL Output Drive Strength = 1 (8 mA) / Low Slew Rate								
t _{DP}	Input Buffer		1.68		1.92		2.26	ns
t _{PY}	Output Buffer		14.28		16.27		19.13	ns
t _{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		15.25		17.37		20.42	ns
t _{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		14.26		16.24		19.09	ns
t _{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.56		1.57		1.58	ns
t _{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		1.95		1.96		1.97	ns
t _{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t _{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Vertical and Horizontal Routing

Vertical and Horizontal Tracks provide both local and long distance routing (Figure 2-37 on page 2-62). These tracks are composed of both short-distance, segmented routing and across-chip routing tracks (segmented at core tile boundaries). The short-distance, segmented routing resources can be concatenated through antifuse connections to build longer routing tracks.

These short-distance routing tracks can be used within and between SuperClusters or between modules of non-adjacent SuperClusters. They can be connected to the Output Tracks and to any logic module input (R-cell, C-cell, Buffer, and TX module).

The across-chip horizontal and vertical routing provides long-distance routing resources. These resources interface with the rest of the routing structures through the RX and TX modules (Figure 2-37). The RX module is used to drive signals from the across-chip horizontal and vertical routing to the Output Tracks within the SuperCluster. The TX module is used to drive vertical and horizontal across-chip routing from either short-distance horizontal tracks or from Output Tracks. The TX module can also be used to drive signals from vertical across-chip tracks to horizontal across-chip tracks and vice versa.

Figure 2-36 • FastConnect Routing

Figure 2-37 • Horizontal and Vertical Tracks



Timing Characteristics

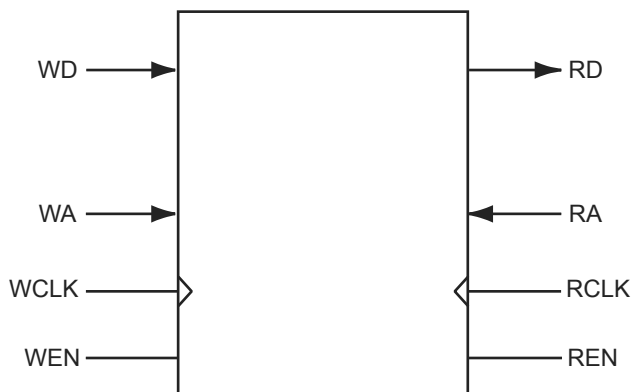


Figure 2-58 • SRAM Model

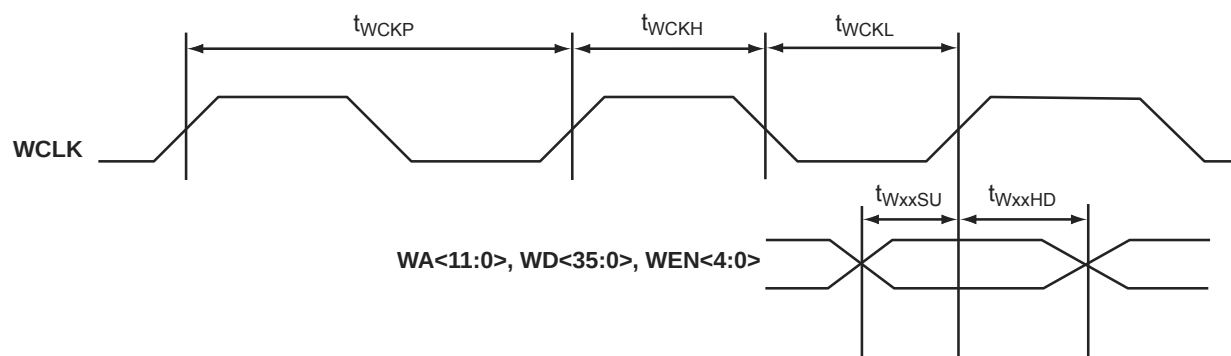


Figure 2-59 • RAM Write Timing Waveforms

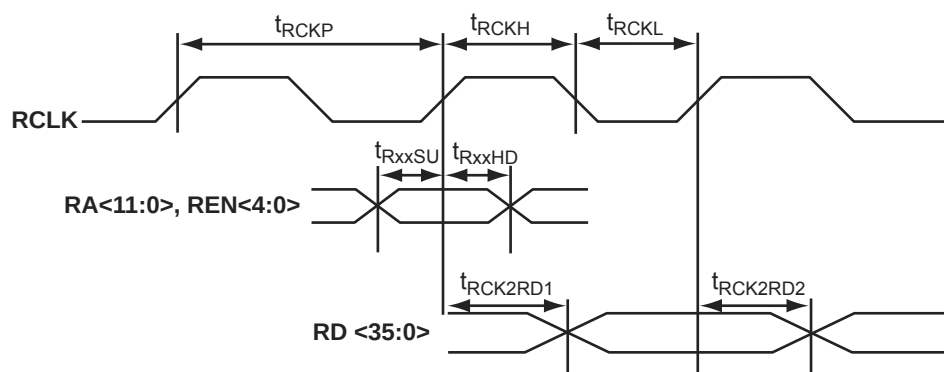


Figure 2-60 • RAM Read Timing Waveforms

FG324		FG324		FG324	
AX125 Function	Pin Number	AX125 Function	Pin Number	AX125 Function	Pin Number
IO50NB4F4/CLKFN	U9	IO66PB6F6	N3	IO83PB7F7	C1
IO50PB4F4/CLKFP	U10	IO67NB6F6	M2	Dedicated I/O	
Bank 5		IO67PB6F6	N2	VCCDA	F5
IO51NB5F5/CLKGN	R8	IO68NB6F6	M1	GND	A1
IO51PB5F5/CLKGP	R9	IO68PB6F6	N1	GND	A18
IO52NB5F5/CLKHN	T7	IO69NB6F6	K4	GND	B17
IO52PB5F5/CLKHP	T8	IO69PB6F6	L4	GND	B2
IO53NB5F5	U6	IO70NB6F6	K1	GND	C16
IO53PB5F5	U7	IO70PB6F6	L1	GND	C3
IO54NB5F5	V8	IO71NB6F6	K3	GND	E16
IO54PB5F5	V9	IO71PB6F6	L3	GND	F13
IO55NB5F5	V6	Bank 7		GND	F6
IO55PB5F5	V7	IO72NB7F7	H4	GND	G12
IO56NB5F5	U4	IO72PB7F7	J4	GND	G7
IO56PB5F5	U5	IO73NB7F7	K2	GND	H10
IO57NB5F5	T4	IO73PB7F7	L2	GND	H11
IO57PB5F5	T5	IO74NB7F7	H2	GND	H8
IO58NB5F5	V4	IO74PB7F7	H1	GND	H9
IO58PB5F5	V5	IO75NB7F7	H3	GND	J10
IO59NB5F5	V2	IO75PB7F7	J3	GND	J11
IO59PB5F5	V3	IO76NB7F7	F2	GND	J8
Bank 6		IO76PB7F7	G2	GND	J9
IO60NB6F6	P5	IO77NB7F7	F1	GND	K10
IO60PB6F6	P6	IO77PB7F7	G1	GND	K11
IO61NB6F6	T2	IO78NB7F7	D2	GND	K8
IO61PB6F6	U3	IO78PB7F7	E2	GND	K9
IO62NB6F6	T1	IO79NB7F7	F3	GND	L10
IO62PB6F6	U1	IO79PB7F7	G3	GND	L11
IO63NB6F6	P1	IO80NB7F7	E3	GND	L8
IO63PB6F6	R1	IO80PB7F7	E4	GND	L9
IO64NB6F6	R3	IO81NB7F7	D1	GND	M12
IO64PB6F6	P3	IO81PB7F7	E1	GND	M7
IO65NB6F6	P2	IO82NB7F7	D3	GND	N13
IO65PB6F6	R2	IO82PB7F7	C2	GND	N6
IO66NB6F6	M3	IO83NB7F7	B1	GND	R14

FG484	
AX1000 Function	Pin Number
IO167PB5F15	AA12
IO169NB5F15	AA9
IO169PB5F15	AA10
IO170NB5F15	AB9
IO170PB5F15	AB10
IO171NB5F16	W8
IO171PB5F16	W9
IO172NB5F16	Y8
IO172PB5F16	Y9
IO173NB5F16	U8
IO173PB5F16	U9
IO174NB5F16	AA7
IO174PB5F16	AA8
IO175NB5F16	AB5
IO175PB5F16	AB6
IO176NB5F16	AA5
IO176PB5F16	AA6
IO177NB5F16	AA4
IO177PB5F16	AB4
IO178NB5F16	Y6
IO178PB5F16	Y7
IO179NB5F16	T7
IO179PB5F16	T8
IO180NB5F16	W6
IO180PB5F16	W7
IO181NB5F17	Y4
IO181PB5F17	Y5
IO184NB5F17	AB7
IO187NB5F17	V3
IO187PB5F17	W3
IO188NB5F17	V4
IO188PB5F17	W5
IO192NB5F17	V6
IO192PB5F17	V7
Bank 6	

FG484	
AX1000 Function	Pin Number
IO194NB6F18	V2
IO194PB6F18	W2
IO195NB6F18	U5
IO195PB6F18	T5
IO200NB6F18	T4
IO200PB6F18	U4
IO201NB6F18	P6
IO201PB6F18	R6
IO203NB6F19	U2
IO204NB6F19	T3
IO204PB6F19	U3
IO205NB6F19	P5
IO205PB6F19	R5
IO208NB6F19	V1
IO208PB6F19	W1
IO209NB6F19	P7
IO209PB6F19	R7
IO212NB6F19	P4
IO212PB6F19	R4
IO214NB6F20	P3
IO214PB6F20	R3
IO215NB6F20	M6
IO215PB6F20	N6
IO216NB6F20	R2
IO216PB6F20	T2
IO217NB6F20	T1
IO217PB6F20	U1
IO219NB6F20	M5
IO219PB6F20	N5
IO220NB6F20	P1
IO220PB6F20	R1
IO221NB6F20	N2
IO221PB6F20	P2
IO222NB6F20	M3
IO222PB6F20	N3

FG484	
AX1000 Function	Pin Number
IO223NB6F20	M7
IO223PB6F20	N7
IO224NB6F20	M4
IO224PB6F20	N4
Bank 7	
IO225NB7F21	M2
IO225PB7F21	N1
IO226NB7F21	K2
IO226PB7F21	K1
IO228NB7F21	L3
IO228PB7F21	L2
IO229NB7F21	K5
IO229PB7F21	L5
IO230NB7F21	H1
IO230PB7F21	J1
IO231NB7F21	H2
IO231PB7F21	J2
IO232NB7F21	K4
IO232PB7F21	K3
IO233NB7F21	K6
IO233PB7F21	L6
IO234NB7F21	F1
IO234PB7F21	G1
IO235NB7F21	F2
IO235PB7F21	G2
IO236NB7F22	H3
IO236PB7F22	J3
IO237NB7F22	K7
IO237PB7F22	L7
IO241NB7F22	H6
IO241PB7F22	J6
IO242NB7F22	H4
IO242PB7F22	J4
IO243NB7F22	H5
IO243PB7F22	J5

FG484		FG484		FG484	
AX1000 Function	Pin Number	AX1000 Function	Pin Number	AX1000 Function	Pin Number
IO246NB7F22	F3	GND	D4	GND	V5
IO246PB7F22	G3	GND	E18	GND	W19
IO250NB7F23	F4	GND	E5	GND	W4
IO250PB7F23	G4	GND	G18	GND	Y20
IO253NB7F23	G5	GND	H15	GND	Y3
IO253PB7F23	G6	GND	H8	GND/LP	G7
IO254NB7F23	D1	GND	J14	PRA	G11
IO254PB7F23	E1	GND	J9	PRB	F11
IO257NB7F23	F5	GND	K10	PRC	T12
IO257PB7F23	E4	GND	K11	PRD	U12
Dedicated I/O		GND	K12	TCK	G8
VCCDA	H7	GND	K13	TDI	F9
GND	A1	GND	L1	TDO	F7
GND	A11	GND	L10	TMS	F6
GND	A12	GND	L11	TRST	F8
GND	A2	GND	L12	VCCA	G17
GND	A21	GND	L13	VCCA	J10
GND	A22	GND	L22	VCCA	J11
GND	AA1	GND	M1	VCCA	J12
GND	AA2	GND	M10	VCCA	J13
GND	AA21	GND	M11	VCCA	J7
GND	AA22	GND	M12	VCCA	K14
GND	AB1	GND	M13	VCCA	K9
GND	AB11	GND	M22	VCCA	L14
GND	AB12	GND	N10	VCCA	L9
GND	AB2	GND	N11	VCCA	M14
GND	AB21	GND	N12	VCCA	M9
GND	AB22	GND	N13	VCCA	N14
GND	B1	GND	P14	VCCA	N9
GND	B2	GND	P9	VCCA	P10
GND	B21	GND	R15	VCCA	P11
GND	B22	GND	R8	VCCA	P12
GND	C20	GND	U16	VCCA	P13
GND	C3	GND	U6	VCCA	T6
GND	D19	GND	V18	VCCA	U17

FG676	
AX500 Function	Pin Number
Bank 0	
IO00NB0F0	F8
IO00PB0F0	E8
IO01NB0F0	A5
IO01PB0F0	A4
IO02NB0F0	E7
IO02PB0F0	E6
IO03NB0F0	D6
IO03PB0F0	D5
IO04NB0F0	B5
IO04PB0F0	C5
IO05NB0F0	B6
IO05PB0F0	C6
IO06NB0F0	C7
IO06PB0F0	D7
IO07NB0F0	A7
IO07PB0F0	A6
IO08NB0F0	C8
IO08PB0F0	D8
IO09NB0F0	F10
IO09PB0F0	F9
IO10NB0F0	B8
IO10PB0F0	B7
IO11NB0F0	D10
IO11PB0F0	E10
IO12NB0F1	B9
IO12PB0F1	C9
IO13NB0F1	F11
IO13PB0F1	G11
IO14NB0F1	D11
IO14PB0F1	E11
IO15NB0F1	B10
IO15PB0F1	C10
IO16NB0F1	A10
IO16PB0F1	A9

FG676	
AX500 Function	Pin Number
IO17NB0F1	F12
IO17PB0F1	G12
IO18NB0F1	C12
IO18PB0F1	C11
IO19NB0F1/HCLKAN	A12
IO19PB0F1/HCLKAP	B12
IO20NB0F1/HCLKBN	C13
IO20PB0F1/HCLKBP	B13
Bank 1	
IO21NB1F2/HCLKCN	C15
IO21PB1F2/HCLKCP	C14
IO22NB1F2/HCLKDN	A15
IO22PB1F2/HCLKDP	B15
IO23NB1F2	F15
IO23PB1F2	G15
IO24NB1F2	B16
IO24PB1F2	A16
IO25NB1F2	A18
IO25PB1F2	A17
IO26NB1F2	D16
IO26PB1F2	E16
IO27NB1F2	F16
IO27PB1F2	G16
IO28NB1F2	C18
IO28PB1F2	C17
IO29NB1F2	B19
IO29PB1F2	B18
IO30NB1F2	D19
IO30PB1F2	C19
IO31NB1F2	F17
IO31PB1F2	E17
IO32NB1F3	B20
IO32PB1F3	A20
IO33NB1F3	B22
IO33PB1F3	B21

FG676	
AX500 Function	Pin Number
IO34NB1F3	D20
IO34PB1F3	C20
IO35NB1F3	D21
IO35PB1F3	C21
IO36NB1F3	D22
IO36PB1F3	C22
IO37NB1F3	F19
IO37PB1F3	E19
IO38NB1F3	B23
IO38PB1F3	A23
IO39NB1F3	E21
IO39PB1F3	E20
IO40NB1F3	D23
IO40PB1F3	C23
IO41NB1F3	D25
IO41PB1F3	C25
Bank 2	
IO42NB2F4	G24
IO42PB2F4	G23
IO43NB2F4	G26
IO43PB2F4	F26
IO44NB2F4	F25
IO44PB2F4	E25
IO45NB2F4	J21
IO45PB2F4	J22
IO46NB2F4	H25
IO46PB2F4	G25
IO47NB2F4	K23
IO47PB2F4	J23
IO48NB2F4	J24
IO48PB2F4	H24
IO49NB2F4	K21
IO49PB2F4	K22
IO50NB2F4	K25
IO50PB2F4	J25

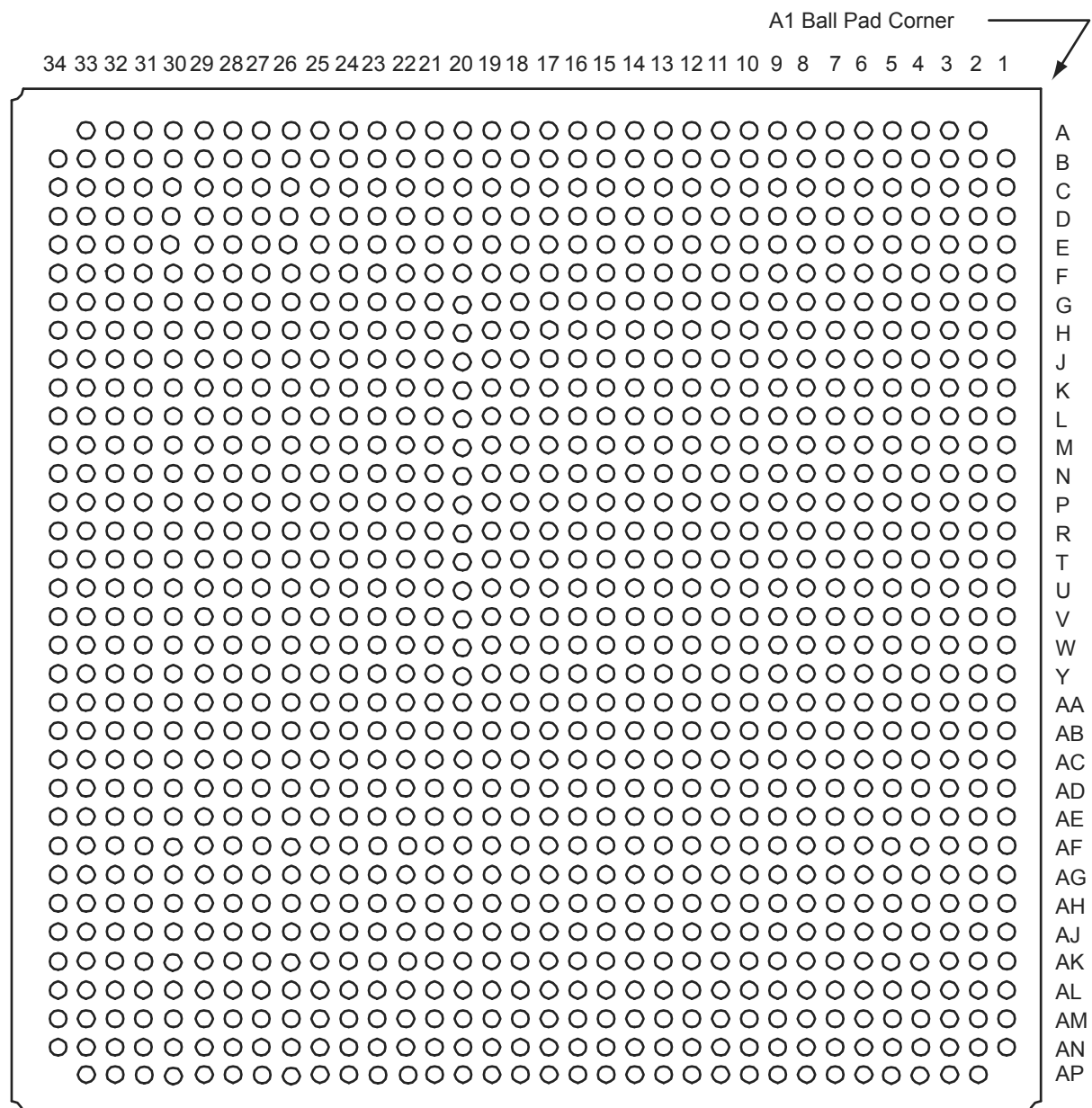
FG896		FG896		FG896	
AX1000 Function	Pin Number	AX1000 Function	Pin Number	AX1000 Function	Pin Number
Bank 0		IO17NB0F1	B11	IO34NB1F3	A17
IO00NB0F0	D6	IO17PB0F1	B10	IO34PB1F3	B17
IO00PB0F0	E6	IO18NB0F1	D11	IO35NB1F3	D18
IO01NB0F0	A5	IO18PB0F1	E11	IO35PB1F3	C18
IO01PB0F0	B5	IO19NB0F1	C12	IO36NB1F3	H17
IO02NB0F0	G9	IO19PB0F1	C11	IO36PB1F3	J17
IO02PB0F0	G8	IO20NB0F1	F12	IO37NB1F3	B19
IO03NB0F0	F8	IO20PB0F1	G12	IO37PB1F3	A19
IO03PB0F0	F7	IO21NB0F1	D12	IO38NB1F3	H18
IO04NB0F0	D7	IO21PB0F1	E12	IO38PB1F3	J18
IO04PB0F0	E7	IO22NB0F2	H13	IO39NB1F3	B20
IO05NB0F0	C7	IO22PB0F2	J13	IO39PB1F3	A20
IO05PB0F0	C6	IO23NB0F2	A12	IO40NB1F3	C20
IO06NB0F0	H9	IO23PB0F2	A11	IO40PB1F3	C19
IO06PB0F0	H8	IO24NB0F2	F13	IO41NB1F4	E20
IO07NB0F0	D8	IO24PB0F2	G13	IO41PB1F4	E19
IO07PB0F0	E8	IO25NB0F2	B13	IO42NB1F4	F18
IO08NB0F0	E9	IO25PB0F2	B12	IO42PB1F4	G18
IO08PB0F0	F9	IO26NB0F2	E14	IO43NB1F4	A22
IO09NB0F0	A7	IO26PB0F2	E13	IO43PB1F4	A21
IO09PB0F0	B7	IO27NB0F2	B14	IO44NB1F4	F20
IO10NB0F0	H10	IO27PB0F2	A14	IO44PB1F4	F19
IO10PB0F0	G10	IO28NB0F2	H14	IO45NB1F4	D21
IO11NB0F0	C9	IO28PB0F2	J14	IO45PB1F4	D20
IO11PB0F0	C8	IO29NB0F2	B15	IO46NB1F4	D22
IO12NB0F1	E10	IO29PB0F2	A15	IO46PB1F4	C22
IO12PB0F1	F10	IO30NB0F2/HCLKAN	C14	IO47NB1F4	A25
IO13NB0F1	D10	IO30PB0F2/HCLKAP	D14	IO47PB1F4	A24
IO13PB0F1	D9	IO31NB0F2/HCLKBN	E15	IO48NB1F4	H19
IO14NB0F1	F11	IO31PB0F2/HCLKBP	D15	IO48PB1F4	G19
IO14PB0F1	G11	Bank 1		IO49NB1F4	C24
IO15NB0F1	A10	IO32NB1F3/HCLKCN	E17	IO49PB1F4	C23
IO15PB0F1	A9	IO32PB1F3/HCLKCP	E16	IO50NB1F4	G20
IO16NB0F1	H12	IO33NB1F3/HCLKDN	C17	IO50PB1F4	H20
IO16PB0F1	H11	IO33PB1F3/HCLKDP	D17	IO51NB1F4	F21

FG896	
AX1000 Function	Pin Number
GND	A13
GND	A18
GND	A2
GND	A23
GND	A29
GND	A8
GND	AA10
GND	AA21
GND	AA28
GND	AA3
GND	AB2
GND	AB22
GND	AB29
GND	AB9
GND	AC1
GND	AC30
GND	AE25
GND	AE6
GND	AF26
GND	AF5
GND	AG27
GND	AG4
GND	AH10
GND	AH15
GND	AH16
GND	AH21
GND	AH28
GND	AH3
GND	AJ1
GND	AJ2
GND	AJ22
GND	AJ29
GND	AJ30
GND	AJ9
GND	AK13

FG896	
AX1000 Function	Pin Number
GND	AK18
GND	AK2
GND	AK23
GND	AK29
GND	AK8
GND	B1
GND	B2
GND	B22
GND	B29
GND	B30
GND	B9
GND	C10
GND	C15
GND	C16
GND	C21
GND	C28
GND	C3
GND	D27
GND	D28
GND	D4
GND	E26
GND	E5
GND	H1
GND	H30
GND	J2
GND	J22
GND	J29
GND	J9
GND	K10
GND	K21
GND	K28
GND	K3
GND	L11
GND	L20
GND	M12

FG896	
AX1000 Function	Pin Number
GND	M13
GND	M14
GND	M15
GND	M16
GND	M17
GND	M18
GND	M19
GND	N1
GND	N12
GND	N13
GND	N14
GND	N15
GND	N16
GND	N17
GND	N18
GND	N19
GND	N30
GND	P12
GND	P13
GND	P14
GND	P15
GND	P16
GND	P17
GND	P18
GND	P19
GND	R12
GND	R13
GND	R14
GND	R15
GND	R16
GND	R17
GND	R18
GND	R19
GND	R28
GND	R3

FG1152



Note

For Package Manufacturing and Environmental information, visit Resource center at <http://www.microsemi.com/soc/products/rescenter/package/index.html>.

CQ352		CQ352		CQ352	
AX1000 Function	Pin Number	AX1000 Function	Pin Number	AX1000 Function	Pin Number
IO131PB4F12	171	IO187PB5F17	99	IO224NB6F20	46
IO132NB4F12	166	IO188NB5F17	100	IO224PB6F20	47
IO132PB4F12	167	IO188PB5F17	101	Bank 7	
IO133NB4F12	164	IO190NB5F17	94	IO225NB7F21	40
IO133PB4F12	165	IO190PB5F17	95	IO225PB7F21	41
IO134NB4F12	160	IO192NB5F17	92	IO226NB7F21	42
IO134PB4F12	161	IO192PB5F17	93	IO226PB7F21	43
IO136NB4F12	158	Bank 6		IO237NB7F22	34
IO136PB4F12	159	IO193PB6F18	86	IO237PB7F22	35
IO137NB4F12	154	IO194NB6F18	84	IO238NB7F22	36
IO137PB4F12	155	IO194PB6F18	85	IO238PB7F22	37
IO138NB4F12	152	IO196NB6F18	78	IO240NB7F22	30
IO138PB4F12	153	IO196PB6F18	79	IO240PB7F22	31
IO153NB4F14	146	IO197NB6F18	82	IO241NB7F22	28
IO153PB4F14	147	IO197PB6F18	83	IO241PB7F22	29
IO159NB4F14/CLKEN	142	IO198NB6F18	76	IO242NB7F22	24
IO159PB4F14/CLKEP	143	IO198PB6F18	77	IO242PB7F22	25
IO160NB4F14/CLKFN	136	IO203NB6F19	72	IO244NB7F22	22
IO160PB4F14/CLKFP	137	IO203PB6F19	73	IO244PB7F22	23
Bank 5		IO204NB6F19	70	IO245NB7F22	18
IO161NB5F15/CLKGN	128	IO204PB6F19	71	IO245PB7F22	19
IO161PB5F15/CLKGP	129	IO205NB6F19	66	IO246NB7F22	16
IO162NB5F15/CLKHN	122	IO205PB6F19	67	IO246PB7F22	17
IO162PB5F15/CLKHP	123	IO206NB6F19	64	IO249NB7F23	12
IO167NB5F15	118	IO206PB6F19	65	IO249PB7F23	13
IO167PB5F15	119	IO207NB6F19	60	IO250NB7F23	10
IO183NB5F17	110	IO207PB6F19	61	IO250PB7F23	11
IO183PB5F17	111	IO208NB6F19	58	IO256NB7F23	4
IO184NB5F17	112	IO208PB6F19	59	IO256PB7F23	5
IO184PB5F17	113	IO211NB6F19	54	IO257NB7F23	6
IO185NB5F17	104	IO211PB6F19	55	IO257PB7F23	7
IO185PB5F17	105	IO212NB6F19	52	Dedicated I/O	
IO186NB5F17	106	IO212PB6F19	53	GND	1
IO186PB5F17	107	IO223NB6F20	48	GND	9
IO187NB5F17	98	IO223PB6F20	49	GND	15

CG624		CG624		CG624	
AX1000 Function	Pin Number	AX1000 Function	Pin Number	AX1000 Function	Pin Number
GND	A8	GND/LP	E8	GND	V1
GND	AA10	GND	H1	GND	V25
GND	AA16	GND	H21	GND	V5
GND	AA18	GND	H25	NC	A14
GND	AA21	GND	K21	NC	AA20
GND	AA5	GND	K23	NC	AB13
GND	AB22	GND	K3	NC	AD4
GND	AB4	GND	L11	NC	AE12
GND	AC10	GND	L12	NC	F21
GND	AC16	GND	L13	NC	G10
GND	AC23	GND	L14	PRA	F13
GND	AC3	GND	L15	PRB	A13
GND	AD1	GND	M11	PRC	AB12
GND	AD2	GND	M12	PRD	AE13
GND	AD24	GND	M13	TCK	F5
GND	AD25	GND	M14	TDI	C5
GND	AE1	GND	M15	TDO	F6
GND	AE18	GND	N11	TMS	D6
GND	AE2	GND	N12	TRST	E6
GND	AE24	GND	N13	VCCA	AB20
GND	AE25	GND	N14	VCCA	F22
GND	AE8	GND	N15	VCCA	F4
GND	B1	GND	P11	VCCA	J17
GND	B2	GND	P12	VCCA	J9
GND	B24	GND	P13	VCCA	K10
GND	B25	GND	P14	VCCA	K11
GND	C10	GND	P15	VCCA	K15
GND	C16	GND	R11	VCCA	K16
GND	C23	GND	R12	VCCA	L10
GND	C3	GND	R13	VCCA	L16
GND	D22	GND	R14	VCCA	R10
GND	D4	GND	R15	VCCA	R16
GND	E10	GND	T21	VCCA	T10
GND	E16	GND	T23	VCCA	T11
GND	E21	GND	T3	VCCA	T15
GND	E5	GND	T5	VCCA	T16

CG624	
AX2000 Function	Pin Number
IO75PB1F6	D17
IO76NB1F7	C21
IO76PB1F7	C20
IO79NB1F7	H20
IO79PB1F7	H19
IO80NB1F7	E18
IO80PB1F7	F18
IO81NB1F7	G21
IO81PB1F7	G20
IO82NB1F7	F20
IO82PB1F7	F19
IO85NB1F7	D20*
IO85PB1F7	D19*
Bank 2	
IO86NB2F8	F23
IO86PB2F8	E23
IO87NB2F8	H23
IO87PB2F8	G23
IO88NB2F8	E24
IO88PB2F8	D24
IO89NB2F8	M17*
IO89PB2F8	G22*
IO91NB2F8	J22
IO91PB2F8	H22
IO92NB2F8	L18
IO92PB2F8	K18
IO96NB2F9	G24
IO96PB2F9	F24
IO97NB2F9	J21
IO97PB2F9	J20
IO98PB2F9	J23
IO99NB2F9	L19

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
IO99PB2F9	K19
IO100NB2F9	E25
IO100PB2F9	D25
IO103PB2F9	K20
IO105NB2F9	M19
IO105PB2F9	M18
IO106NB2F9	J24
IO106PB2F9	H24
IO107NB2F10	L23*
IO107PB2F10	N16*
IO109NB2F10	L22
IO109PB2F10	K22
IO110NB2F10	G25
IO110PB2F10	F25
IO111NB2F10	L21
IO111PB2F10	L20
IO112NB2F10	L24
IO112PB2F10	K24
IO113NB2F10	N17
IO115NB2F10	M20
IO115PB2F10	M21
IO117NB2F10	N19
IO117PB2F10	N18
IO118NB2F11	J25
IO121NB2F11	N24
IO121PB2F11	M24
IO122NB2F11	L25
IO122PB2F11	K25
IO123NB2F11	N22
IO123PB2F11	M22
IO124NB2F11	N23
IO124PB2F11	M23

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
IO127NB2F11	P18
IO127PB2F11	P17
IO128NB2F11	N25
IO128PB2F11	M25
Bank 3	
IO129NB3F12	N20
IO130PB3F12	P24
IO131NB3F12	P21
IO133NB3F12	P20
IO133PB3F12	P19
IO138NB3F12	R23
IO138PB3F12	P23
IO139NB3F13	R22
IO139PB3F13	P22
IO141NB3F13	R19
IO142NB3F13	R25
IO142PB3F13	P25
IO143PB3F13	R21
IO145NB3F13	T18
IO145PB3F13	R18
IO146NB3F13	T24
IO146PB3F13	R24
IO147NB3F13	T20
IO147PB3F13	R20
IO148NB3F13	U25
IO148PB3F13	T25
IO149NB3F13	T22
IO153NB3F14	U19
IO153PB3F14	T19
IO154NB3F14	Y25
IO154PB3F14	W25
IO157NB3F14	V20

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
VCCIB2	D23
VCCIB2	E22
VCCIB2	K17
VCCIB2	L17
VCCIB2	M16
VCCIB3	AA22
VCCIB3	AB23
VCCIB3	AC24
VCCIB3	AC25
VCCIB3	P16
VCCIB3	R17
VCCIB3	T17
VCCIB4	AB21
VCCIB4	AC22
VCCIB4	AD23
VCCIB4	AE23
VCCIB4	T14
VCCIB4	U15
VCCIB4	U16
VCCIB5	AB5
VCCIB5	AC4
VCCIB5	AD3
VCCIB5	AE3
VCCIB5	T12
VCCIB5	U10
VCCIB5	U11
VCCIB6	AA4
VCCIB6	AB3
VCCIB6	AC1
VCCIB6	AC2
VCCIB6	P10
VCCIB6	R9

Note: **Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*

CG624	
AX2000 Function	Pin Number
VCCIB6	T9
VCCIB7	C1
VCCIB7	C2
VCCIB7	D3
VCCIB7	E4
VCCIB7	K9
VCCIB7	L9
VCCIB7	M10
VCCPLA	E12
VCCPLB	J12
VCCPLC	E14
VCCPLD	H14
VCCPLE	Y14
VCCPLF	U14
VCCPLG	Y12
VCCPLH	U12
VCOMPLA	F12
VCOMPLB	H12
VCOMPLC	F14
VCOMPLD	J14
VCOMPLE	AA14
VCOMPLF	V14
VCOMPLG	AA12
VCOMPLH	V12
VPUMP	E20

Note: **Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*

Revision	Changes	Page
Revision 3 (continued)	The timing characteristics tables from pages 2-26 to 2-60 were updated.	2-26 to 2-60
	The "Global Resources" section was updated.	2-66
	The timing characteristics tables from pages 2-102 to 2-103 were updated.	2-102 to 2-103
	The "PQ208", "FG256", and "FG324" tables are new.	3-9,3-16, 3-84